IGBT - Field Stop

600 V, 40 A

FGH40N60SMDF-F085

Description

Using Novel Field Stop IGBT Technology, ON Semiconductor new series of Field Stop IGBTs offer the optimum performance for Automotive Chargers, Inverter, and other applications where low conduction and switching losses are essential.

Features

- Max Junction Temperature $T_J = 175^{\circ}C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.7 V (Typ.) @ I_C = 40 A$
- High Input Impedance
- Fast Switching : E_{OFF} = 6.25 uJ/A
- Tighten Parameter Distribution
- Qualified to Automotive Requirements of AEC-Q101
- This Device is Pb-Free and is RoHS Compliant

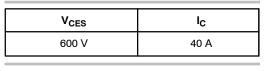
Applications

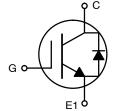
- Automotive Chargers, Converters, High Voltage Auxiliaries
- Inverters, PFC, UPS

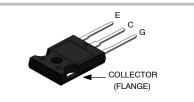


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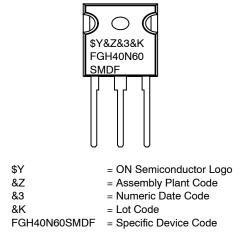






TO-247-3LD CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Symbol	Description		Ratings	Unit
V _{CES}	Collector to Emitter Voltage		600	V
V_{GES}	Gate to Emitter Voltage		±20	V
Ι _C	Collector Current	T _C = 25°C	80	А
		$T_C = 100^{\circ}C$	40	А
I _{CM} (Note 1)	Pulsed Collector Current	$T_{\rm C} = 25^{\circ}{\rm C}$	120	А
PD	Maximum Power Dissipation $T_{C} = 25^{\circ}C$		349	W
		$T_{C} = 100^{\circ}C$	174	W
TJ	Operating Junction Temperature		–55 to +175	°C
T _{STG}	Storage Temperature Range		–55 to +175	°C
TL	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Symbol	Parameter	Тур.	Unit
R _{0JC} (IGBT)	Thermal Resistance, Junction to Case	0.43	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	1.45	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Qty per Tube
FGH40N60SMDF-F085	FGH40N60SMDF	TO-247	Tube	N/A	N/A	30

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
	TERISTICS					
BV _{CES}	Collector to Emitter Breakdown Voltage	V_{GE} = 0 V, I_{C} = 250 μ A	600	-	-	V
$\Delta BV_{CES} / \Delta T_{J}$	Temperature Coefficient of Breakdown Voltage	V _{GE} = 0 V, I _C = 250 μA	-	0.6	-	V/°C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
N CHARACT	ERISTICS					
V _{GE(th)}	G-E Threshold Voltage	I_C = 250 μ A, V_{CE} = V_{GE}	3.5	4.8	6.0	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 40 A, V _{GE} = 15 V,	-	1.7	2.5	V
		I_{C} = 40 A, V_{GE} = 15 V, T_{C} = 150°C	_	2.0	_	V
YNAMIC CHA	ARACTERISTICS					
C _{ies}	Input Capacitance	V _{CE} = 30 V, V _{GE} = 0 V,	-	1840	-	pF
C _{oes}	Output Capacitance	f = 1 MHz	-	180	-	pF
C _{res}	Reverse Transfer Capacitance		-	50	-	pF
WITCHING C	HARACTERISTICS					
T _{d(on)}	Turn-On Delay Time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A},$ $R_{G} = 6 \Omega, V_{GE} = 15 \text{ V},$ Inductive Load, $T_{C} = 25^{\circ}\text{C}$	-	18	-	ns
T _r	Rise Time		-	22	-	ns
T _{d(off)}	Turn-Off Delay Time		-	110	-	ns
T _f	Fall Time		-	11	20	ns
Eon	Turn-On Switching Loss		-	1.3	-	mJ
E _{off}	Turn–Off Switching Loss		-	0.25	-	mJ
E _{ts}	Total Switching Loss		-	1.55	-	mJ
T _{d(on)}	Turn-On Delay Time	$V_{\rm CC} = 400 \text{ V}, \text{ I}_{\rm C} = 40 \text{ A},$	-	18	_	ns
T _r	Rise Time	$R_G = 6 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 125^{\circ}C$	-	32	-	ns
T _{d(off)}	Turn-Off Delay Time		-	112	-	ns
T _f	Fall Time		-	11	20	ns
Eon	Turn–On Switching Loss		-	2.05	-	mJ
E _{off}	Turn-Off Switching Loss		-	0.48	-	mJ
E _{ts}	Total Switching Loss		-	2.53	-	mJ
Qg	Total Gate Charge	$V_{CE} = 400 \text{ V}, I_C = 40 \text{ A},$	-	122	-	nC
Q _{ge}	Gate to Emitter Charge	$V_{GE}^{2} = 15 V$	-	11	-	nC
Q _{gc}	Gate to Collector Charge	1	_	59	_	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Symbol	Parameter	Test Co	Min	Тур	Max	Unit	
V _{FM}	Diode Forward Voltage	I _F = 20 A	$T_{C} = 25^{\circ}C$	-	1.3	1.7	V
			T _C = 150°C	-	1.2	-	
T _{rr}	Diode Reverse Recovery Time	I _F = 20 A, dI _F /dt = 200 A/μs	$T_{\rm C} = 25^{\circ}{\rm C}$	-	57	90	ns
		$\alpha_{\rm F}/\alpha_{\rm c} = 200 R/\mu_0$	T _C = 125°C	-	130	-	
Q _{rr}	Diode Reverse Recovery Charge		$T_C = 25^{\circ}C$	-	164	290	nC
			$T_{C} = 125^{\circ}C$	-	718	-	

ELECTRICAL CHARACTERISTICS OF THE DIODE ($T_C = 25^{\circ}C$ unless otherwise noted)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

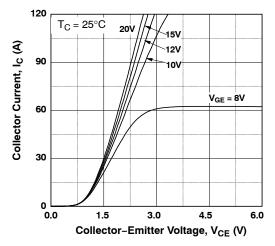


Figure 1. Typical Output Characteristics

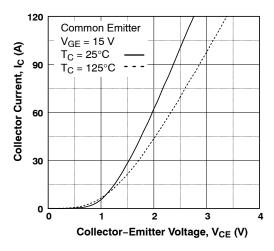


Figure 3. Typical Saturation Voltage Characteristics

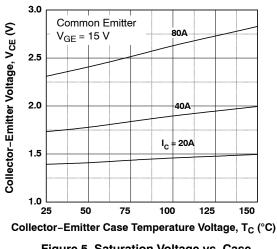


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

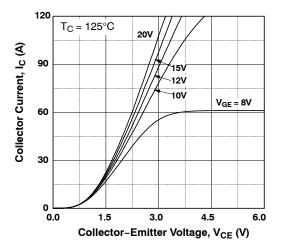


Figure 2. Typical Output Characteristics

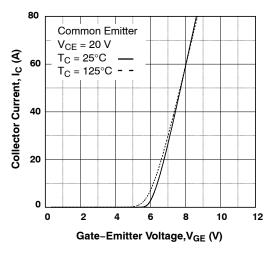


Figure 4. Transfer Characteristics

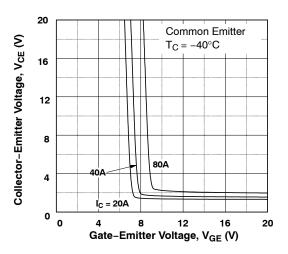


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

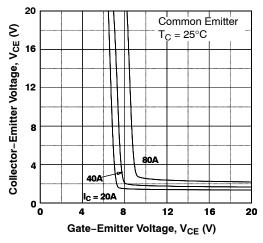


Figure 7. Saturation Voltage vs V_{GE}

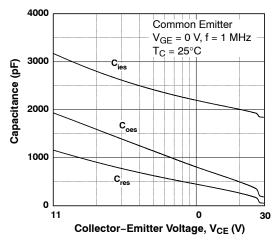
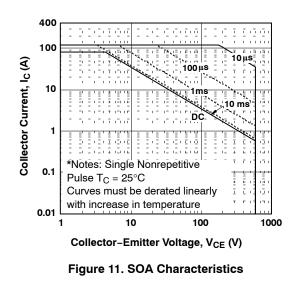


Figure 9. Capacitance Characteristics



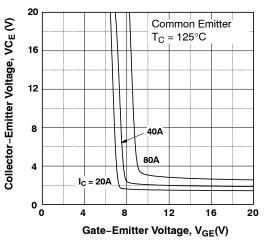


Figure 8. Saturation Voltage vs VGE

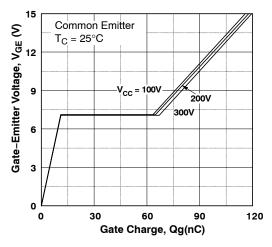
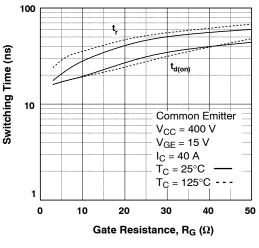
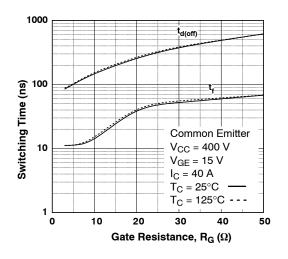


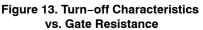
Figure 10. Gate Charge Characteristics

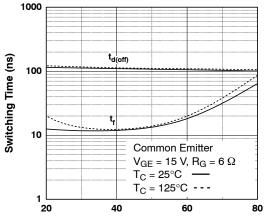




TYPICAL PERFORMANCE CHARACTERISTICS (Continued)







Collector Current, I_C (A)

Figure 15. Turn-off Characteristics vs. Collector Current

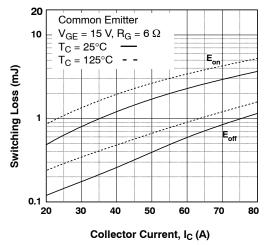


Figure 17. Switching Loss vs. Collector Current

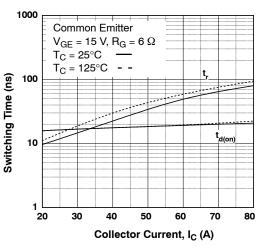
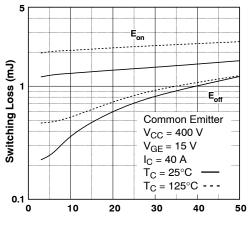
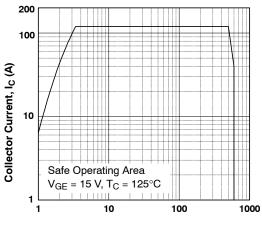


Figure 14. Turn-on Characteristics vs. Collector Current



Gate Resistance, $R_{G}(\Omega)$

Figure 16. Switching Loss vs. Gate Resistance



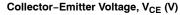


Figure 18. Turn Off Switching SOA Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

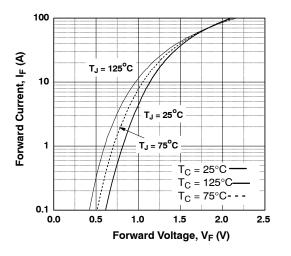


Figure 19. Forward Characteristics

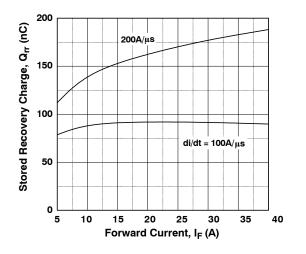


Figure 21. Stored Charge

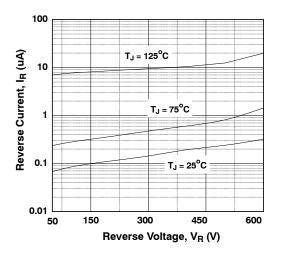


Figure 20. Reverse Current

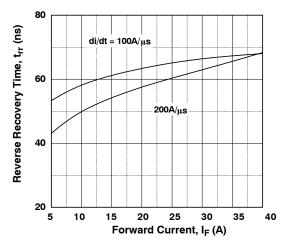


Figure 22. Reverse Recovery Time

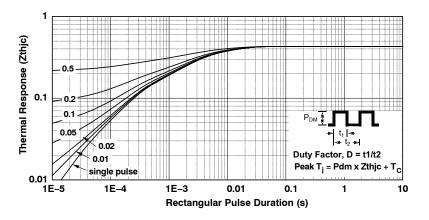


Figure 23. Transient Thermal Impedance of IGBT





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